



SEMICONDUCTOR TECHNICAL DATA

KMB4D0N30SA

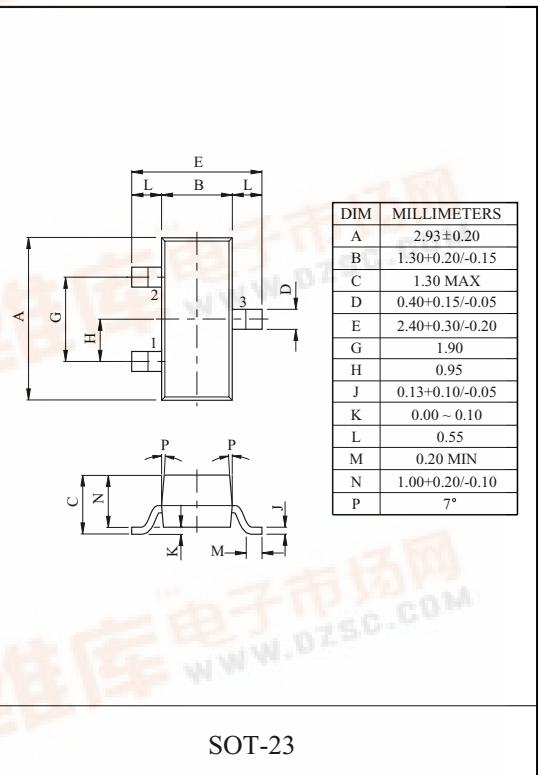
N-Ch Trench MOSFET

General Description

This Trench MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for portable equipment and SMPS.

FEATURES

- $V_{DSS}=30V$, $I_D=4A$
- Drain-Source ON Resistance
 $R_{DS(ON)}=47m\Omega$ (Max.) @ $V_{GS}=10V$
 $R_{DS(ON)}=65m\Omega$ (Max.) @ $V_{GS}=4.5V$
- Super Hige Dense Cell Design

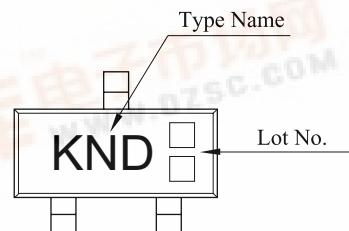


MAXIMUM RATING (Ta=25 °C)

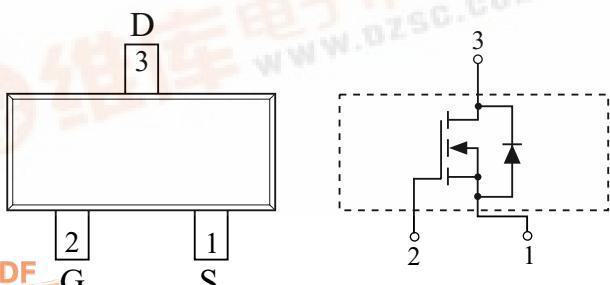
CHARACTERISTIC	SYMBOL	N-Ch	UNIT
Drain-Source Voltage	V_{DSS}	30	V
Gate-Source Voltage	V_{GSS}	± 20	V
Drain Current	$DC@T_A=25\text{ }^\circ\text{C}$	4.0	A
	$DC@T_A=70\text{ }^\circ\text{C}$	3.5	
	I_{DP}	20	
Drain-Source-Diode Forward Current	I_S	1.04	A
Drain Power Dissipation	$T_A=25\text{ }^\circ\text{C}$	1.25	W
	$T_A=70\text{ }^\circ\text{C}$	0.8	
Maximum Junction Temperature	T_j	150	°C
Storage Temperature Range	T_{stg}	-55 ~ 150	°C
Thermal Resistance, Junction to Ambient	R_{thJA}	130	°C/W

Note : Surface Mounted on FR4 Board, $t \leq 10\text{ sec}$.

Marking



PIN CONNECTION (TOP VIEW)



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ELECTRICAL CHARACTERISTICS (Ta=25°C)

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Fig1. V_{DS} - I_D

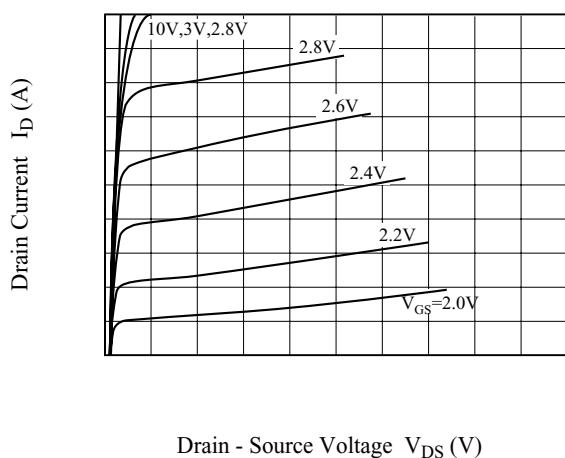


Fig2. $R_{DS(ON)}$ - I_D

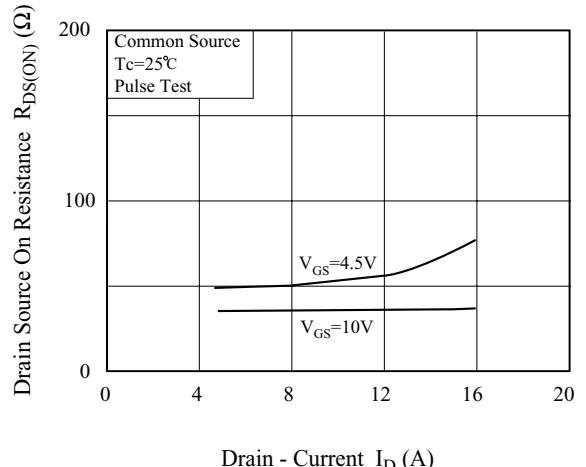


Fig3. V_{GS} - I_D

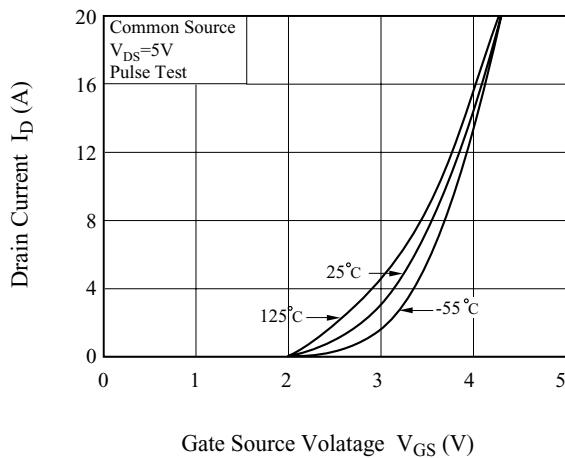


Fig4. $R_{DS(ON)}$ - T_j

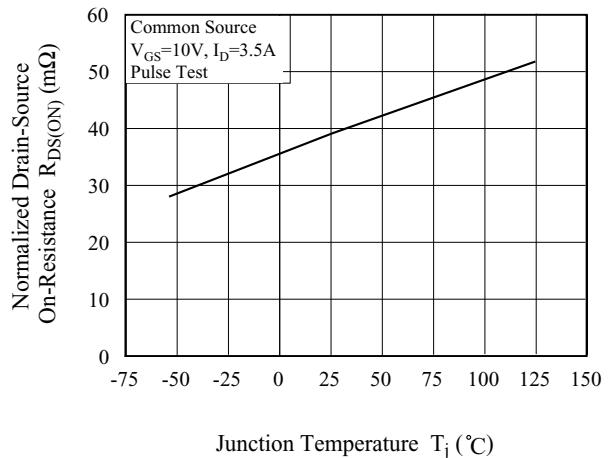


Fig5. V_{th} - T_j

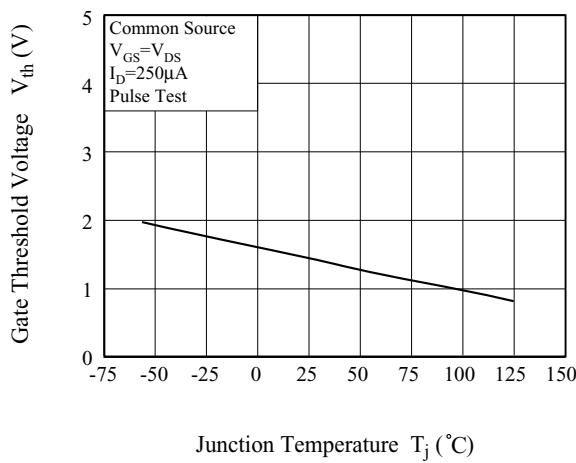
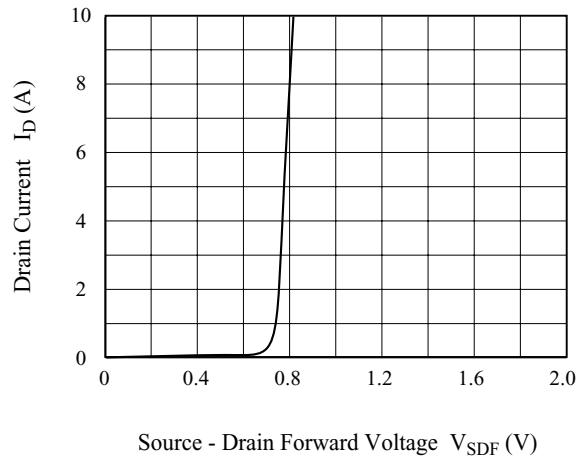


Fig6. I_S - V_{SDF}



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Fig7. Transient Thermal Response Curve

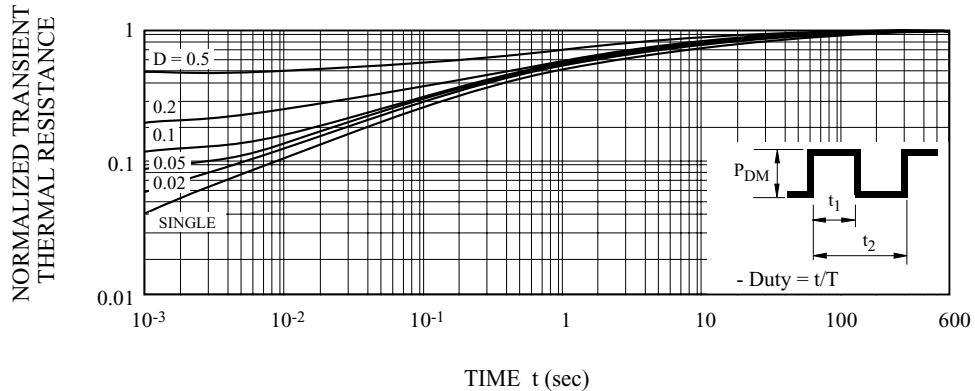
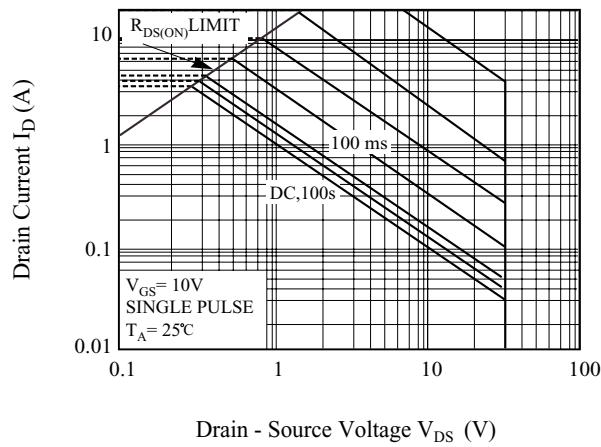


Fig8. Safe Operation Area



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Fig9. Gate Charge Circuit and Wave Form

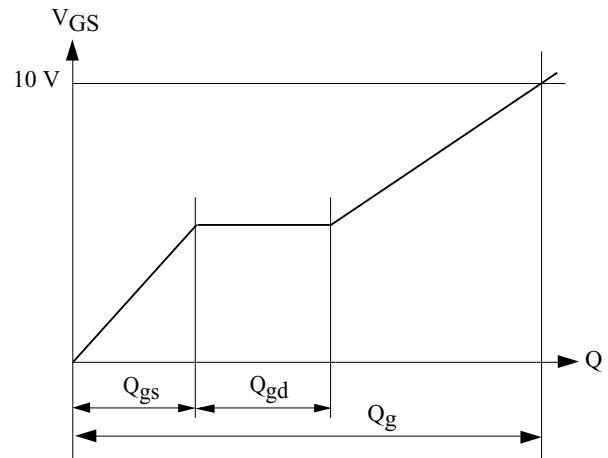
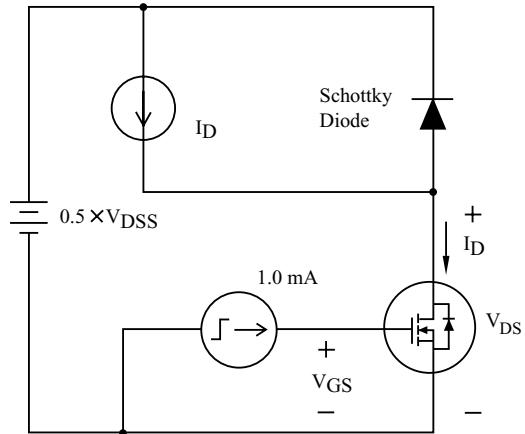


Fig10. Resistive Load Switching

